cRIO-9041 Specifications





Contents

cRIO-9041 Specifications.

cRIO-9041 Specifications

Definitions

Warranted specifications describe the performance of a model under stated operating conditions and are covered by the model warranty.

Characteristics describe values that are relevant to the use of the model under stated operating conditions but are not covered by the model warranty.

- **Typical** specifications describe the performance met by a majority of models.
- *Nominal* specifications describe an attribute that is based on design, conformance testing, or supplemental testing.

Specifications are *Typical* unless otherwise noted.

Conditions

Specifications are valid for -40 °C to 70 °C unless otherwise noted.

Processor

CPU	Intel Atom E3930		
Number of cores	2		
CPU frequency	1.3 GHz (base), 1.8 GHz (burst)		
On-die L2 cache	2 MB		

Software

Note For minimum software support information, visit <u>ni.com/r/SWsupport</u>.

Supported operating system		NI Linux Real-Time (64-bit)
Supported C Series module programming modes		Real-Time (NI-DAQmx) Real-Time Scan (I/O Variables) LabVIEW FPGA
Application software		
LabVIEW LabVIEW 2017 or later, LabVIEW Real-Time Module 2017 or later, LabVIEW FPGA Module 2017 or later		

Note LabVIEW FPGA Module is not required when using Real-Time Scan (I/O Variables) mode or Real-Time (NI-DAQmx) mode. To program the user-accessible FPGA on the cRIO-9041, the LabVIEW FPGA Module is required.

Note C/C++ Development Tools for NI Linux Real-Time is an optional interface for C/C++ programming of the cRIO-9041 processor. Visit <u>ni.com/r/RIOCdev</u> for more information about the C/C++ Development Tools for NI Linux Real-Time. For information on setting up a C/C++ based toolchain, visit <u>ni.com/r/NILRTCrossCompile</u>.

Driver software	NI CompactRIO Device Drivers December 2017 or later

Network/Ethernet Port

Number of ports	2	
Network interface	10Base-T, 100Base-TX, and 1000Base-T Ethernet	
Compatibility	IEEE 802.3	
Communication rates	10 Mb/s, 100 Mb/s, 1,000 Mb/s, auto-negotiated	
Maximum cabling distance	100 m/segment	

Network Timing and Synchronization

Protocol	IEEE 802.1AS-2011 IEEE 1588-2008 (default end-to-end profile)
Supported Ethernet ports	Port 0, port 1
Network synchronization accuracy	<1 µs



Note Network synchronization is system-dependent. For information about network synchronization accuracy, visit <u>ni.com/r/criosync</u>.



Note The cRIO-9041 employs time-aware transmission support.

RS-232 Serial Port

Maximum baud rate	115,200 b/s
Data bits	5, 6, 7, 8
Stop bits	1, 2
Parity	Odd, even, mark, space
Flow control	RTS/CTS, XON/XOFF, DTR/DSR
RI wake maximum low level	0.8 V
RI wake minimum high level	2.4 V
RI overvoltage tolerance	±24 V

RS-485 Serial Port

Maximum baud rate	230,400 b/s		
Data bits	5, 6, 7, 8		
Stop bits	1, 2		

Parity	Odd, even, mark, space		
Flow control	XON/XOFF		
Wire mode	4-wire, 2-wire, 2-wire auto		
Isolation voltage	60 V DC continuous, port to earth ground		

Note The RS-485 serial port ground and shield are functionally isolated from chassis ground to prevent ground loops, but do not meet IEC 61010-1 for safety isolation.

Cable requirement	Unshielded, 30 m maximum length (limited by EMC/surge)	
-------------------	--	--

Note RS-485 is capable of 1.2 km (4,000 ft) length without surge limitation.

USB Ports

Port 1: •<	
Туре	USB Type-A, host port
USB interface	USB 2.0, Hi-Speed
Maximum data rate	480 Mb/s

Maximum current			900 mA	
Port 2: <i>ss</i> -, ₪				
Туре		USB Type-C, host port		
USB interface		USB 3.1 Gen1, SuperSpeed		
Maximum data rate		5 Gb/s		
Maximum current		900 mA		
Alternate modes		DisplayPort		
Port 3: <i>ss<</i>				
Туре	USB Type-C, dual role port (device or host)			
USB interface	USB 3.1 Gen1, SuperSpeed			
Maximum data rate	5 Gb/s			
Maximum current	900 mA			

DisplayPort over USB Type-C

Maximum resolution	3840 × 2160 at 60 Hz

Supported standard	DisplayPort 1.2
Supported USB ports	Port 2: <i>ss</i>

SD Card Slot

SD card support	SD and SDHC standards
Supported interface speeds	UHS - I SDR50 and DDR50

I Notice Full and high speed SD cards are prohibited for use with the cRIO-9041.

Memory

Nonvolatile memory (SSD)	4 GB
Nonvolatile memory (SSD) type	Planar SLC NAND

Note Visit <u>ni.com/r/ssdbp</u> for information about the life span of the nonvolatile memory and about best practices for using nonvolatile memory.

Volatile memory (DRAM)		
Density	2 GB	

Туре	DDR3L
Maximum theoretical data rate	12.8 GB/s

Reconfigurable FPGA

FPGA type	Xilinx Kintex-7 7K70T
Number of flip-flops	82,000
Number of 6-input LUTs	41,000
Number of DSP slices (18 × 25 multipliers)	240
Available block RAM	4,860 kbits
Number of DMA channels	16
Number of logical interrupts	32

Internal Real-Time Clock

Accuracy	200 ppm; 40 ppm at 25 °C
----------	--------------------------

Controller PFI 0

Maximum input or output frequency		1 MHz	
able length		3 m (10 ft)	
Cable impedance		50 Ω	
PFI 0 connector		SMB	
Power-on state		High impedance	
I/O standard compatibility	O standard compatibility		
O voltage protection		±30 V	
Maximum operating conditions			
_{OL} output low current 8 mA ma		ximum	
output high current -8 mA maximum		aximum	

Table 1. DC Input Characteristics

Voltage	Minimum	Maximum
Positive going threshold	1.43 V	2.28 V
Negative going threshold	0.86 V	1.53 V
Hysteresis	0.48 V	0.87 V

Voltage	Conditions	Minimum	Maximum
High	—	—	5.25 V
	Sourcing 100 μA	4.65 V	_
	Sourcing 2 mA	3.60 V	_
	Sourcing 3.5 mA	3.44 V	_
Low	Sinking 100 μA	—	0.10 V
	Sinking 2 mA		0.64 V
	Sinking 3.5 mA	_	0.80 V

Table 2. DC Output Characteristics

Real-Time Streaming Performance

Data throughput is dependent on the application, system, and performance of the removable storage media. For information about optimizing data throughput on the cRIO-9041, visit <u>ni.com/r/optdata</u>.

Data throughput from system memory to target		
SD card	40 MB/s	
USB Type-C	100 MB/s	

Real-Time (NI-DAQmx) Mode

The following specifications are applicable for modules and slots programmed in Real-Time (NI-DAQmx) mode. For more information about using modules in LabVIEW FPGA mode or Real-Time Scan (I/O Variables) mode, visit <u>ni.com/r/swsupport</u>.

Analog Input

Input FIFO size	253 samples per slot
Maximum sample rate	Determined by the C Series module or modules
Timing accuracy	50 ppm of sample rate
Timing resolution	12.5 ns
Number of channels supported	Determined by the C Series module or modules
Number of hardware-timed tasks	8

Note Maximum sample rate performance is dependent on type of installed C Series module and number of channels in the task.

Note Timing accuracy does not include group delay. For more information, refer to the documentation for each C Series module.

Analog Output

Hardware-timed tasks			
Number of hardware-timed tasks		8	
Number of channels supported			
Onboard regeneration	16		

Non-regeneration	Determined by the C Series module or modules		
Non-hardware-timed tasks	, 		
Number of non-hardware-timed tasks Determined by the C Series module or mod		ies module or modules	
Number of channels supported		Determined by the C Seri	ies module or modules
Maximum update rate			1.6 MS/s

Note Streaming applications are limited by system-dependent factors and the capability of C Series modules.

Timing accuracy	50 ppm of sample rate
Timing resolution	12.5 ns
Waveform onboard regeneration FIFO	8,191 samples shared among channels used
Waveform streaming FIFO	253 samples per slot

Digital Waveform

Waveform acquisition (DI) FIFO	
Parallel modules	255 samples per slot

Serial modules		127 sai	mples per slot
Waveform onboard regenerat	tion (DO) FIFO)	
Parallel modules	2,047 samples shar		among slots used
Waveform streaming (DO) FIF	0		
Parallel modules		255 sai	nples per slot
Serial modules		127 samples per slot	
Sample clock frequency			
Digital input		0 MHz to	10 MHz
Digital output			
ot0:6 timing engine			0 MHz to 3.5 MHz
ot7 timing engine			0 MHz to 10 MHz
			1

Note Streaming applications are limited by system-dependent factors and the capability of C Series modules.

Timing accuracy	50 ppm
Number of digital input hardware-timed tasks	8

8

General-Purpose Counters/Timers

Number of counters/ timers	4
Resolution	32 bits
Counter measurements	Edge counting, pulse, semi-period, period, two-edge separation, pulse width
Position measurements	X1, X2, X4 quadrature encoding with Channel Z reloading; two-pulse encoding
Output applications	Pulse, pulse train with dynamic updates, frequency division, equivalent time sampling
Internal base clocks	80 MHz, 20 MHz, 13.1072 MHz, 12.8 MHz, 10 MHz, 100 kHz
External base clock frequency	0 MHz to 20 MHz
Base clock accuracy	50 ppm
Output frequency	0 MHz to 20 MHz

Inputs	Gate, Source, HW_Arm, Aux, A, B, Z, Up_Down
Routing options for inputs	Any module PFI, controller PFI, analog trigger, many internal signals
FIFO	Dedicated 127-sample FIFO

Frequency Generator

Number of channels	1
Base clocks	20 MHz, 10 MHz, 100 kHz
Divisors	1 to 16 (integers)
Base clock accuracy	50 ppm
Output	Any controller PFI or module PFI terminal

Module PFI

Functionality	Static digital input, static digital output, timing input, and timing output
Timing output sources	Many analog input, analog output, counter, digital input, and digital output timing signals

Timing input frequency	0 MHz to 20 MHz
Timing output frequency	0 MHz to 20 MHz

Note Actual available timing output source signals are dependent on type of installed C Series module.

Digital Triggers

Source	Any controller PFI or module PFI terminal		
Polarity	Software-selectable for most signals		
Analog input function	Start Trigger, Reference Trigger, Pause Trigger, Sample Clock, Sample Clock Timebase		
Analog output function	Start Trigger, Pause Trigger, Sample Clock, Sample Clock Timebase		
Counter/timer function	Gate, Source, HW_Arm, Aux, A, B, Z, Up_Down		

Module I/O States

At power-on	Module-dependent. Refer to the documentation for each C Series module.
-------------	--

Time-Based Triggers and Timestamps

Number of time-based triggers			5
Number of timestamps	Number of timestamps 6		
Analog input	1		
Time-based triggers Start Trigger, Sync Pulse			
Timestamps Start Trigger, Reference Trigger, First Sample			
Analog output			
Time-based triggers		Start Trigger, Sync Pulse	
Timestamps		Start Trigger, First Sample	
Digital input			
Time-based triggers	ne-based triggers Start Trigger		
Timestamps Start Trigger, Reference Trigger, First Sample			
Digital output			
Time-based triggers		Start Trigger	
Timestamps		Start Trigger, First Sample	
Counter/timer input			

Time-based triggers		Arm Start Trigger
Timestamps		Arm Start Trigger
Counter/timer output	·	
Time-based triggers	Start Trigger	, Arm Start Trigger
Timestamps	Start Trigger	, Arm Start Trigger

CMOS Battery

Typical battery life with power applied to power connector	10 years
Typical battery life when stored at temperatures up to 25 °C	7.8 years
Typical battery life when stored at temperatures up to 85 °C	5.4 years

Power Requirements

Note Some C Series modules have additional power requirements. For more information about C Series module power requirements, refer to the C Series module(s) documentation.

Note Sleep mode for C Series modules is not supported in Real-Time (DAQmx) Mode.

Voltage input range (measured at the cRIO-9041 power connector)

V1	9 V to 30 V	
V2	9 V to 30 V	
Maximum power consum	ption	60 W

Note The C terminal of the power connector is functionally isolated from chassis ground to prevent ground loops, but does not meet IEC 61010-1 for safety isolation

Note The maximum power consumption specification is based on a fully populated system running a high-stress application at elevated ambient temperature and with all C Series modules and USB devices consuming the maximum allowed power.

Typical standby power consumption	3.4 W at 24 V DC input	
Recommended power supply	100 W, 24 V DC	
Typical leakage current from secondary power input (V2) while system is powered from primary		

 power input (V1)
 0.4 mA

 At 9 V
 0.4 mA

 At 30 V
 1.93 mA



Notice Do not connect V2 to a DC Mains supply or to any supply that requires a connecting cable longer than 3 m(10 ft). A DC Mains supply is a

local DC electricity supply network in the infrastructure of a site or building. V1 may be connected to DC Mains.

Notice Include a switch or circuit breaker in the installation to disconnect the system from DC Mains. The switch or circuit breaker must be suitably rated, accessible, and marked as the disconnecting device for the system.

EMC ratings for inputs as described in IEC 61000				
V1	Short lines, long lines, and DC distributed networks			
V2	Short lines only			
	Power input4-position, 3.5 mm pitch, pluggable screw terminal with screw locks,connectorSauro CTF04BV8-AN000A			

Battery Guidelines

Caution Fire, explosion, and severe burn hazard. Do not open, crush, insert improperly, recharge or disassemble the battery. Do not heat the battery or the product above 100 °C. Do not incinerate the battery or the product. Do not expose the battery contents to water. Take precautions to ensure correct polarity of the battery in the product. Risk of explosion if battery is replaced by an incorrect type. Dispose of used batteries according to the instructions.

Attention Risque d'incendie, d'explosion et de brûlures graves. Ne pas ouvrir, écraser, recharger ou démonter la pile. Ne pas chauffer la pile ou le produit au-dessus de 100 °C. Ne pas incinérer la pile ou le produit. Éviter tout contact du contenu de la pile avec de l'eau. Prenez des précautions pour vous assurer que la polarité de la batterie dans le produit est correcte. Risque d'explosion si la pile est remplacée par un type de pile incorrect. Reportezvous à la documentation de l'appareil sur ni.com/manuals pour obtenir des informations sur le remplacement, l'élimination et le recyclage de sa pile.



Caution The battery must be replaced by a trained service technician. Refer to the product documentation on <u>ni.com/manuals</u> for instructions for replacing the battery.



Attention La pile doit être remplacée par un technicien de maintenance qualifié. Reportez-vous à la documentation du produit sur ni.com/manuals pour obtenir les instructions pour changer la pile.

Battery Rating		
Manufacturer	Tadiran	
Model	TLH-2450/P	
Quantity	1	
Cell chemistry system	Lithium Thionyl Chloride	

Physical Characteristics

Weight (unloaded)	1,800 g (3 lb, 15 oz)			
Dimensions (unloaded)	219.5 mm × 88.1 mm × 121.2 mm (8.64 in. × 3.47 in. × 4.77 in.)			
Power connector wiring				
Gauge	0.5 mm ² to 2.1 mm ² (20 AWG to 14 AWG) copper conductor wire			

Wire strip length	6 mm (0.24 in.) of insulation stripped from the end		
Temperature rating	85 °	c	
Torque for screw terminals	0.20 N · m to 0.25 N · m (1.8 lb · in. to 2.2 lb · in.)		
Wires per screw terminal	One wire per screw terminal		
Connector securement			
Securement type		Screw flanges provided	
Torque for screw flanges		0.20 N · m to 0.25 N · m (1.8 lb · in. to 2.2 lb · in.)	
Insulation rating 300 V, r		maximum	

Safety Voltages

Connect only voltages that are below these limits.

V1 terminal to C terminal	30 V, maximum
V2 terminal to C terminal	30 V, maximum
Chassis ground to C terminal	30 V, maximum

Environmental Characteristics

Temperature				
Operating		-40 °C to 70 °C		
Storage		-40 °C to 85 °C		
Humidity				
Operating	10% RH to 90% RH, noncondensing			
Storage	5% RH to 95% RH, noncondensing			
Ingress protection				IP20
Pollution Degree				2
Maximum altitude				5,000 m
Shock and Vibration				
Operating vibration				
Random 5 g RMS		MS,1	S, 10 Hz to 500 Hz	
Sinusoidal 5 g, 10 H		0 Hz	: to 500 Hz	
Operating shock 30 g, 11 ms half sine; 50 g, 3 ms half sine; 18 shocks at 6 orientations				

To meet these specifications, you must mount the cRIO-9041 system directly on a flat, rigid surface as described in the user manual, affix ferrules to the ends of the terminal wires, and use retention accessories for the USB 2.0 host port (NI USB Extender Cable, 152166-xx), USB type-C ports (NI Locking USB Cables, 143556-xx; NI USB Extender Cable, 143555-xx; NI USB Display Adapters, 143557-xx or 143558-xx). All cabling should be strain-relieved near input connectors. Take care to not directionally bias cable connectors within input connectors when applying strain relief.